

AMENDMENTS



None.

In the Claims

Please replace the claims with the following clean version of the entire set of pending claims, in accordance with 37 C.F.R. § 1.121(c)(1)(i). Cancel all previous versions of any pending claim.

No amended or new claims are presented herein.

CLAIMS

- 1. Integrated circuitry comprising a capacitor comprising a first capacitor electrode, a second capacitor electrode and a high K capacitor dielectric region received therebetween; the high K capacitor dielectric region comprising a high K substantially amorphous material layer and a high K substantially crystalline material layer, the high K substantially amorphous material and the high K substantially crystalline material constituting different chemical compositions, the high K substantially crystalline material being received over the high K substantially amorphous material.
- 4. The integrated/circuitry of claim 1 wherein at least one of the first and second electrodes comprises elemental metal, metal alloy, conductive metal oxides, or mixtures thereof.

- 5. The integrated circuitry of claim 1 wherein at least one of the high K substantially amorphous material layer and the high K substantially crystalline material layer contacts at least one of the first capacitor electrode and the second capacitor electrode.
- 6. The integrated circuitry of claim 1 wherein the high K substantially amorphous material layer contacts at least one of the first capacitor electrode and the second capacitor electrode.
- 7. The integrated circuitry of claim 6 wherein the high K substantially amorphous material layer contacts only one of the first capacitor electrode and the second capacitor electrode.
- 8. The integrated circuitry of claim 1 wherein the high K substantially amorphous material layer contacts one of the first and second capacitor electrodes and the high K substantially crystalline material layer contacts the other of the first and second capacitor electrodes.
- 9. The integrated circuitry of claim 1 wherein the high K capacitor dielectric region is the only capacitor dielectric region received between the first and second capacitor electrodes, and consists essentially of the high K substantially amorphous material layer and the high K substantially crystalline material layer.

- 10. The integrated circuitry of claim 1 wherein the high K substantially amorphous material layer is at least 98% amorphous, and the high K substantially crystalline material layer is at least 98% crystalline.
- 11. The integrated circuitry of claim 1 comprising a semiconductor substrate, the capacitor being received at least partially over the semiconductor substrate, the high K substantially crystalline material layer being received between the semiconductor substrate and the high K substantially amorphous material layer.
- 12. The integrated circuitry of claim 11 wherein the semiconductor substrate comprises bulk monocrystalline silicon.
- 13. The integrated circuitry of claim 11 wherein at least one of the high K substantially amorphous material layer and the high K substantially crystalline material layer contacts at least one of the first capacitor electrode and the second capacitor electrode.
- 14. The integrated circuitry of claim 11 wherein the high K substantially amorphous material layer contacts at least one of the first capacitor electrode and the second capacitor electrode.

Cont.

- 15. The integrated circuitry of claim 1 comprising a semiconductor substrate, the capacitor being received at least partially over the semiconductor substrate, the high K substantially amorphous material layer being received between the semiconductor substrate and the high K substantially crystalline material layer.
- 16. The integrated circuitry of claim 15 wherein the semiconductor substrate comprising bulk monocrystalline silicon.